

## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of:

Redline, et al.

Docket No.: 2156

Serial No.: 09/251,641

Filed:

February 17, 1999

Title:

Method For Enhancing Solderability

Surface

Honorable Commissioner of Patents and Trademarks Washington, D.C. 20231

INFORMATION DISCLOSURE STATEMENT

Pursuant to Sections 609 and 707.05(b) of the MPEP and 37 CFR 1.97-1.99, a copy is herewith submitted of documents that may be pertinent to the invention as claimed in the above-identified application. The attached form PTO-1449 (1 page) lists these documents individually.

This Information Disclosure Statement is being filed before the mailing date of a final Office action or a Notice Please charge Deposit Account No.: 50-0447 in of Allowance. the amount of \$240, plus any deficiencies, to cover the filing of this Information Disclosure Statement. citation of these documents should not be construed as a representation that a thorough search has been made, or that other, more pertinent material is not available.

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Respectfully submitted,

Cordani, Reg. 37,297

armody & Torrance LLP

50 Leavenworth Street

P.O. Box 1110

Waterbury, CT 06721-1110

(203) 578-4271